

64-Position Up/Down Control Digital Potentiometer

AD5227

FEATURES

64-position digital potentiometer 10 kΩ, 50 kΩ, 100 kΩ end-to-end terminal resistance Simple up/down digital or manual configurable control Midscale preset Low potentiometer mode tempco = 10 ppm/°C Low rheostat mode tempco = 35 ppm/°C Ultralow power, $I_{DD} = 0.4 \mu A$ typ and 3 μA max **Fast adjustment time, ts = 1 µs Chip select enable multiple device operation Low operating voltage, 2.7 V to 5.5 V Automotive temperature range, −40°C to +105°C Compact thin SOT-23-8 (2.9 mm × 3 mm) Pb-free package**

APPLICATIONS

Mechanical potentiometer and trimmer replacements LCD backlight, contrast, and brightness controls Portable electronics level adjustment Programmable power supply Digital trimmer replacements Automatic closed-loop control

GENERAL DESCRIPTION

The AD5227 is Analog Devices' latest 64-step up/down control digital potentiometer¹. This device performs the same electronic adjustment function as a 5 V potentiometer or variable resistor. Its simple 3-wire up/down interface allows manual switching or high speed digital control. The AD5227 presets to midscale at power-up. When \overline{CS} is enabled, the devices changes step at every clock pulse. The direction is determined by the state of the U/\overline{D} pin (see Table 1). The interface is simple to activate by any host controller, discrete logic, or manually with a rotary encoder or pushbuttons. The AD5227's 64-step resolution, small footprint, and simple interface enable it to replace mechanical potentiometers and trimmers with typically 6× improved resolution, solid-state reliability, and design layout flexibility, resulting in a considerable cost savings in end users' systems.

FUNCTIONAL BLOCK DIAGRAM

The AD5227 is available in a compact thin SOT-23-8 (TSOT-8) Pb-free package. The part is guaranteed to operate over the automotive temperature range of −40°C to +105°C.

Users who consider EEMEM potentiometers should refer to some recommendations in the Applications section.

Table 1. Truth Table

 \overline{a}

¹ R_{WA} increments if R_{WB} decrements and vice versa.

¹ The terms *digital potentiometer* and RDAC are used interchangeably.

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REVISION HISTORY

Revision 0: Initial Version

ELECTRICAL CHARACTERISTICS

10 kΩ, 50 kΩ, 100 kΩ versions: $V_{DD} = 3 V \pm 10\%$ or $5 V \pm 10\%$, $V_A = V_{DD}$, $V_B = 0 V$, $-40\degree C < T_A < +105\degree C$, unless otherwise noted.

Footnotes on the next page.

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 1 Typicals represent average readings at 25°C, V $_{\rm DD}$ = 5 V.
2 Resistor position poplinearity error, R-INL, is the deviati

² Resistor position nonlinearity error, R-INL, is the deviation from an ideal value measured between the maximum resistance and the minimum resistance wiper

positions. R-DNL measures the relative step change from ideal between successive tap positions. Parts are guaranteed monotonic.

³ NL and DNL are measured at V_W with the RDAC configured as a potentiometer divider similar to a voltage output D/A converter. V_A = V_{DD} and V_B = 0 V.
⁴ DNL specification limits of +1 LSB maximum are quaranteed

 4 DNL specification limits of ± 1 LSB maximum are quaranteed monotonic operating conditions. ⁵ Resistor Terminals A, B, W have no limitations on polarity with respect to each other.

Guaranteed by design and not subject to production test.

 7 P_{DISS} is calculated from (I_{DD} × V_{DD}). CMOS logic level inputs result in minimum power dissipation.
⁸ Bandwidth, noise, and settling time are dependent on the terminal resistance value chosen. The

⁸ Bandwidth, noise, and settling time are dependent on the terminal resistance value chosen. The lowest R value results in the fastest settling time and highest bandwidth. The highest R value results in the minimum overall power consumption.
⁹ All dynamic characteristics use $V_{DD} = V$.

¹⁰ All input control voltages are specified with t_R = t_F = 1 ns (10% to 90% of V_{DD}) and timed from a voltage level of 1.6 V. Switching characteristics are measured using $V_{DD} = 5 V$.

INTERFACE TIMING DIAGRAMS

Figure 4. Detailed Timing Diagram (Only R_{WB} Decrement Shown)

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ABSOLUTE MAXIMUM RATINGS

Table 3.

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¹ Maximum terminal current is bounded by the maximum applied voltage across any two of the A, B, and W terminals at a given resistance, the maximum current handling of the switches, and the maximum power dissipation of the package. $V_{DD} = 5$ V.

² Package power dissipation = $(T_J$ max - T_A) / θ_{JA}.

Stresses above those listed under Absolute Maximum Ratings may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational section of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

ESD CAUTION

ESD (electrostatic discharge) sensitive device. Electrostatic charges as high as 4000 V readily accumulate on the human body and test equipment and can discharge without detection. Although this product features proprietary ESD protection circuitry, permanent damage may occur on devices subjected to high energy electrostatic discharges. Therefore, proper ESD precautions are recommended to avoid performance degradation or loss of functionality.

PIN CONFIGURATION AND FUNCTION DESCRIPTIONS

Figure 5. SOT-23-8 Pin Configuration

Table 4. Pin Function Descriptions

TYPICAL PERFORMANCE CHARACTERISTICS

Figure 6. R-INL vs. Code vs. Temperature, $V_{DD} = 5$ V

Figure 7. R-DNL vs. Code vs. Temperature, $V_{DD} = 5 V$

Figure 8. INL vs. Code, $V_{DD} = 5$ V

Figure 9. DNL vs. Code vs. Temperature, $V_{DD} = 5$ V

Figure 10. Full-Scale Error vs. Temperature

Figure 11. Zero-Scale Error vs. Temperature

Figure 14. Wiper Resistance vs. Temperature

Figure 15. Rheostat Mode Tempco ∆RWB/∆T vs. Code

Figure 17. Gain vs. Frequency vs. Code, $R_{AB} = 10 \text{ k}\Omega$

Figure 21. I_{DD} vs. CLK Frequency

Figure 23. Step Change Settling Time

THEORY OF OPERATION

The AD5227 is a 64-position 3-terminal digitally controlled potentiometer device. It presets to a midscale at system poweron. When CS is enabled, changing the resistance settings is achieved by clocking the CLK pin. It is negative-edge triggered, and the direction of stepping is determined by the state of the U/\overline{D} input. When the wiper reaches the maximum or the minimum setting, additional CLK pulses do not change the wiper setting.

Figure 24. Functional Block Diagram

Figure 25. AD5227 Equivalent RDAC Circuit

PROGRAMMING THE DIGITAL POTENTIOMETERS Rheostat Operation

If only the W-to-B or W-to-A terminals are used as variable resistors, the unused terminal can be opened or shorted with W. This operation is called *rheostat mode* and is shown in Figure 26.

Figure 26. Rheostat Mode Configuration

The end-to-end resistance, RAB, has 64 contact points accessed by the wiper terminal, plus the B terminal contact, assuming that RWB is used (see Figure 25). Clocking the CLK input steps, R_{WB} by one step. The direction is determined by the state of U/D pin. The change of R_{WB} can be determined by the number of clock pulses, provided that the AD5227 has not reached its maximum or minimum scale. ∆R_{WB} can, therefore, be approximated as

$$
\Delta R_{WB} = \pm \left(CP \times \frac{R_{AB}}{64} + R_W \right) \tag{1}
$$

where:

CP is the number of clock pulses.

RAB is the end-to-end resistance.

RW is the wiper resistance contributed by the on-resistance of the internal switch.

Since in the lowest end of the resistor string a finite wiper resistance is present, care should be taken to limit the current flow between W and B in this state to a maximum pulse current of no more than 20 mA. Otherwise, degradation or possible destruction of the internal switches can occur.

Similar to the mechanical potentiometer, the resistance of the RDAC between the Wiper W and Terminal A also produces a digitally controlled complementary resistance, R_{WA}. When these terminals are used, the B terminal can be opened or shorted to W. Similarly, ∆R_{WA} can be approximated as

$$
\Delta R_{WA} = \pm \left(\left(64 - CP \right) \frac{R_{AB}}{64} + R_W \right) \tag{2}
$$

Equations 1 and 2 do not apply when $CP = 0$.

The typical distribution of the resistance tolerance from device to device is process lot dependent. It is possible to have ±20% tolerance.

Potentiometer Mode Operation

If all three terminals are used, the operation is called *potentiometer mode.* The most common configuration is the voltage divider operation as shown in Figure 27.

Figure 27. Potentiometer Mode Configuration

The change of V_{WB} is known provided that the AD5227 has not reached the maximum or minimum scale. If one ignores the effect of the wiper resistance, the transfer functions can be simplified as

$$
\Delta V_{WB} = +\frac{CP}{64} V_A |U/\overline{D} = 1
$$
\n(3)

$$
\Delta V_{WB} = -\frac{CP}{64} V_A | U/\overline{D} = 0
$$
 (4)

Unlike rheostat mode operation where the absolute tolerance is high, potentiometer mode operation yields an almost ratiometric function of CP/64 with a relatively small error contributed by the R_W term. The tolerance effect is, therefore, almost canceled. Although the thin film step resistor, R_s, and CMOS switches resistance, RW, have very different temperature coefficients, the ratiometric adjustment also reduces the overall temperature coefficient to 5 ppm/°C except at low value codes where R_W dominates.

Potentiometer mode operation includes an op amp gain configuration among others. The A, W, and B terminals can be input or output terminals and have no polarity constraint provided that $|V_{AB}|$, $|V_{WA}|$, and $|V_{WB}|$ do not exceed V_{DD} -to-GND.

DIGITAL INTERFACE

The AD5227 contains a 3-wire serial input interface. The three inputs are clock (CLK), chip select (\overline{CS}) , and up/down control (U/D). These inputs can be controlled digitally for optimum speed and flexibility

When \overline{CS} is pulled low, a clock pulse increments or decrements the up/down counter. The direction is determined by the state of the U/ \overline{D} pin. When a specific state of the U/ \overline{D} remains, the device continues to change in the same direction under consecutive clocks until it comes to the end of the resistance setting. All digital inputs, \overline{CS} , CLK, and U/D pins, are protected with a series input resistor and a parallel Zener ESD structure as shown in Figure 28.

Figure 28. Equivalent ESD Protection Digital Pins

TERMINAL VOLTAGE OPERATION RANGE

The AD5227 is designed with internal ESD protection diodes (Figure 29), but the diodes also set the boundary of the terminal operating voltages. Voltage present on Terminal A, B, or W that exceeds V_{DD} by more than 0.5 V is clamped by the diode and, therefore, elevates V_{DD} . There is no polarity constraint between V_{AB} , V_{WA} , and V_{WB} , but they cannot be higher than V_{DD} -to-GND.

POWER-UP AND POWER-DOWN SEQUENCES

Because of the ESD protection diodes, it is important to power on V_{DD} before applying any voltage to Terminals A, B, and W. Otherwise, the diodes are forward-biased such that V_{DD} can be powered unintentionally and can affect the rest of the system circuit. Similarly, V_{DD} should be powered down last. The ideal power-on sequence is in the following order: GND, V_{DD} , $V_{A/B/W}$, and digital inputs.

Figure 29. Maximum Terminal Voltages Set by V_{DD} and GND

LAYOUT AND POWER SUPPLY BIASING

It is a good practice to use compact, minimum lead length layout design. The leads to the input should be as direct as possible with a minimum conductor length. Ground paths should have low resistance and low inductance. It is also good practice to bypass the power supplies with quality capacitors. Low ESR (equivalent series resistance) 1 μ F to 10 μ F tantalum or electrolytic capacitors should be applied at the supplies to minimize any transient disturbance and filter low frequency ripple.

Figure 30 illustrates the basic supply bypassing configuration for the AD5227. The ground pin of the AD5227 is a digital ground reference that should be joined to the common ground at a single point to minimize the digital ground bounce.

Figure 30. Power Supply Bypassing

APPLICATIONS **MANUAL CONTROL WITH TOGGLE AND PUSHBUTTON SWITCHES**

The AD5227's simple interface allows it to be used with mechanical switches for simple manual operation. The states of the $\overline{\text{CS}}$ and $U/\overline{\text{D}}$ can be selected by toggle switches and the CLK input can be controlled by a pushbutton switch. Because of the numerous bounces due to contact closure, the pushbutton switch should be debounced by flip-flops or by the ADM812 as shown in Figure 31.

Figure 31. Manual Push Button Up/Down Control

MANUAL CONTROL WITH ROTARY ENCODER

Figure 32 shows another way of using AD5227 to emulate mechanical potentiometer in a rotary knob operation. The rotary encoder U1 has a C ground terminal and two out-ofphase signals, A and B. When U1 is turned clockwise, a pulse generated from the B terminal leads a pulse generated from the A terminal and vice versa. Signals A and B of U1 pass through a quadrature decoder U2 that translates the phase difference between A and B of U1 into compatible inputs for U3 AD5227. Therefore, when B leads A (clockwise), U2 provides the AD5227 with a logic high U/\overline{D} signal, and vice versa. U2 also filters noise, jitter, and other transients as well as debouncing the contact bounces generated by U1.

Figure 32. Manual Rotary Control

ADJUSTABLE LED DRIVER

The AD5227 can be used in many electronics-level adjustments such as LED drivers for LCD panel backlight control. Figure 33 shows an adjustable LED driver. The AD5227 sets the voltage across the white LED D1 for the brightness control. Since U2 handles up to 250 mA, a typical white LED with V_F of 3.5 V requires a resistor, R1, to limit the U2 current. This circuit is simple but not power-efficient, therefore the U2 shutdown pin can be toggled with a PWM signal to conserve power.

Figure 33. Low Cost Adjustable LED Driver

ADJUSTABLE CURRENT SOURCE FOR LED DRIVER

Since LED brightness is a function of current rather than forward voltage, an adjustable current source is preferred over a voltage source as shown in Figure 34.

Figure 34. Adjustable Current Source for LED Driver

The load current can be found as the V_{WB} of the AD5227 divided by RSET.

$$
I_D = \frac{V_{WB}}{R_{SET}}\tag{5}
$$

The U1 ADP3333ARM-1.5 is a 1.5 V LDO that is lifted above or lowered below 0 V. When V_{WB} of the AD5227 is at minimum, there is no current through D1, so the GND pin of U1 would be at –1.5 V if U3 were biased with the dual supplies. As a result, some of the U2 low resistance steps have no effect on the output until the U1 GND pin is lifted above 0 V. When V_{WB} of the AD5227 is at its maximum, V_{OUT} becomes $V_L + V_{AB}$, so the U1 supply voltage must be biased with adequate headroom. Similarly, a PWM signal can be applied at the U1 shutdown pin for power efficiency. This circuit works well for a single LED.

ADJUSTABLE HIGH POWER LED DRIVER

Figure 35 shows a circuit that can drive three to four high power LEDs. ADP1610 is an adjustable boost regulator that provides the voltage headroom and current for the LEDs. The AD5227 and the op amp form an average gain of 12 feedback network that servos the R_{SET} voltage and ADP1610's FB pin 1.2 V band gap reference voltage. As the loop is set, the voltage across R_{SET} is regulated around 0.1 V and adjusted by the digital potentiometer.

$$
I_{LED} = \frac{V_{R_{SET}}}{R_{SET}}\tag{6}
$$

RSET should be small enough to conserve power but large enough to limit maximum LED current. R3 should also be used in parallel with AD5227 to limit the LED current within an achievable range. A wider current adjustment range is possible by lowering the R2 to R1 ratio, as well as changing R3 accordingly.

Figure 35. Adjustable Current Source for LEDs in Series

AUTOMATIC LCD PANEL BACKLIGHT CONTROL

With the addition of a photocell sensor, an automatic brightness control can be achieved. As shown in Figure 36, the resistance of the photocell changes linearly but inversely with the light output. The brighter the light output, the lower the photocell resistance and vice versa. The AD5227 sets the voltage level that is gained up by U2 to drive N1 to a desirable brightness. With the photocell acting as the variable feedback resistor, the change in the light output changes the R2 resistance, therefore causing U2 to drive N1 accordingly to regulate the output. This simple low cost implementation of the LED controller can compensate for the temperature and aging effects typically found in high power LEDs. Similarly, for power efficiency, a PWM signal can be applied at the gate of N2 to switch the LED on and off without any noticeable effect.

Figure 36. Automatic LCD Panel Backlight Control

6-BIT CONTROLLER

The AD5227 can form a simple 6-bit controller with a clock generator, a comparator, and some output components. Figure 37 shows a generic 6-bit controller with a comparator that first compares the sampling output with the reference level and outputs either a high or low level to the AD5227 U/ \overline{D} pin. The AD5227 then changes step at every clock cycle in the direction indicated by the U/\overline{D} state. Although this circuit is not as elegant as the one shown in Figure 36, it is self-contained, very easy to design, and can adapt to various applications.

Figure 37. 6-Bit Controller

CONSTANT BIAS WITH SUPPLY TO RETAIN RESISTANCE SETTING

Users who consider EEMEM potentiometers but cannot justify the additional cost and programming for their designs can consider constantly biasing the AD5227 with the supply to retain the resistance setting as shown in Figure 38. The AD5227 is designed specifically with low power to allow power conservation even in battery-operated systems. As shown in Figure 39, a similar low power digital potentiometer is biased with a 3.4 V 450 mA/hour Li-Ion cell phone battery. The measurement shows that the device drains negligible power. Constantly biasing the potentiometer is a practical approach because most portable devices do not require detachable batteries for charging. Although the resistance setting of the AD5227 is lost when the battery needs to be replaced, this event occurs so infrequently that the inconvenience is minimal for most applications.

Figure 38. Constant Bias AD5227 for Resistance Retention

Figure 39. Battery Consumption Measurement

OUTLINE DIMENSIONS

COMPLIANT TO JEDEC STANDARDS MO-193BA

Figure 40. 8-Lead Small Outline Transistor Package TSOT-8 [Thin SOT-23-8] (UJ-8) Dimensions shown in millimeters

ORDERING GUIDE

¹ The end-to-end resistance R_{AB} is available in 10 kΩ, 50 kΩ, and 100 kΩ versions. The final three characters of the part number determine the nominal resistance value, for example, 10 k Ω = 10.
² Z = Pb-free part.

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NOTES

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